

CAPABILITY DOMAIN: Thin Film Hermetic Hybrid Microcircuits

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	Executive Member: ESA				Date: 02/11/2022					
Capability domain submitted f	or approval									1
Capability Domain Description				Based on Technology		Test Structures				
Thin film Hybrids	NORS/2038/ Capability At Kongsberg H	Thin film hybrid technology		STH-1080_TV STH-2130_TV STH-2291_TV STH-2915_TV STH-2923_TV						
Component Manufacturer Kongsberg Defence & Aerospace AS	Location of manufacturing plant(s) Knudsrødveien 7 N-3189 Horten Norway				3	ESCC Speci Capability Ap Generic: ES Details: ES	pproval CC25600	ls	ssue 1	
Report reference: NORS/2038/TPF/QUR001 HYB PCA Test report ESA-TECQEC-LAB-TR-2022-002958 Date: 22/08/2022 PID used for Reference in R			o.: NOR				98			ϵ
PID Changes since start of Capability Approval None Minor* * provide details in Box 12 Major*				Current PID Verified by: S. Hernandez, ESA Name of Executive Representative Ref. No.: NORS/HYBRID/GEN/MIF/PID1198 Issue: 4 Date: 01/09/2022						
Current Manufacturing Facilitie	es and Quality	System audit	ed							9
by: S.Hernandez, ESA 11/05/2022 Name of Executive Representative Agency Date					NORS/2038/ECF/20220511 S Audit and Line Survey Report Reference Number					
Satisfactory: Yes ⊠ No □ Corrective Actions Closed Out: Yes ⊠ No □ N/A □										
Quality and Reliability Data										10
Evaluation testing performed Report Ref. No.: NORS/HYB PCA Equivalent data: ESA Contract No. 4000128544/19/ NORS/HYB_PCA/ECF/MOM005 Certification: Yes	/ECF/MOM005	No □			(supply d Ref. Nos.	ata) and purp	, DPA, NCCS 00se: .AB-TR-2022			No 🗆



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Executive Member:

ESA

Date:02/11/2022

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The undersigned hereby certifies on behalf of the ESCC Executive, that the above information is correct; that the appropriate documentation has been evaluated; that full compliance to all ESCC requirements is evidenced except as stated in box 13; that the reports and data are available at the ESCC Executive and therefore applies for ESCC Capability Approval status to be given to the capability domain defined herein.

Date:

Anastasia Pesce Digitally signed by Anastasia Pesce

Date: 2022.11.25 09:56:03

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(Signature of the Executive Coordinator)

signature of the Executive econamictor,

Continuation of Boxes above:

PID Change log from issue 3 to issue 4:

- · Updated abbreviations list
- Added reference document RD-13 and RD-14 in section 1.2
- Updated number of employees in section 2.1.
- Updated organisation chart in section 2.2
- Updated manufacturing area figure in section 3.1.
- Added KASKo procedures to the relevant chapters in section 3.
- Specified that the portable particle sensor is also used for ISO class regualification purposes in section 3.4
- Added ATP (Applied Thinfilm Products) to list of suppliers in Table 4 1
- Updated maximum package and lid size in section 4.8.
- Added lead integrity test, solderability test, destructive bond pull test and die shear test in section 5.1.
- Updated PS-70617 to issue 4 (ref. RD-13) in Table 5 1
- Included PIND amplifier, accelerometer, and STU in Table 6 1
- Replaced Components with Component families in Section 7.6.1
- Included material, dimensions, and metallisation for item 98726 in section 7.6.1.6
- Updated elongation data on item 81914 section 7.6.1.19
- Updated text in section 7.6.1.31
- Updated adhesion layer specification item 96066 section 7.6.1.31
- Standardised item description section 7.6.1.38
- Added Hybrid types text in section 8
- Updated exceptions and added part on manufacturer "category 1" in section 9.

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		Executive Member: ESA	Date: 0)2/11/2022		
Non comp	liance to ESCC	requirements:				13
No.:		Specification	Paragraph	Non	compliance	
			, and graph		Somphanico	
-						
Additional noncomplia	tasks required to ance:	o achieve full compliance for	ESCC Capability Approval or ratio	nale for acceptabilit	y of	14
1 12						
Executive	Manager Dispo	osition:				15
Application	Approval:	Yes ⊠ No □				
Action/Ren	narks:					
Date:			4	3. D	1	2
			B. Schad	e: Head of the Prod	uct Assurance	

And Safety Department



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Executive Member: ESA

NOTES ON THE COMPLETION OF THE APPLICATION FORM FOR ESCC CAPABILITY APPROVAL [or its EXTENSION, see BOX 12 below]

GENERAL Whenever possible, all entries should be typed and in any case be suitable for legible reproduction by normal

means.

ENTRIES

Form heading shall indicate: - the title of the capability domain or the technology as given in the Capability Abstract - the

Executive Member; - the entering date; - the serial number and the suffix of the form.

Box 1 shall provide under capability domain description the full name or a description statement of the capability

domain – the number of the Capability Abstract document – the basic technology used for capability approval – the test structures specification numbers or identification numbers – the components which successfully

passed component approval test and are proposed for qualification within the domain.

N.B. The capability abstract shall be attached as an Appendix.

Box 2 and 3 Manufacturer's name and location of the plant(s) where the capability domain is situated.

Box 4 The ESCC Generic and Detail specifications (including issue number and date) used during Capability

Approval.

Box 5 Reference to test report(s) submitted in support of the application for capability approval and components

proposed for qualification.

Box 6 Enter details to identify the PID that was applicable at the time of manufacturing of samples for capability

approval testing.

Box 7 If the PID has been changed during or after capability approval testing, adequate details shall be provided

together with the reasons for change. Major changes shall be clearly identified.

Box 8 The box serves to identify the current PID and the Executive Representative that has verified it together with

the date of this verification.

Box 9 The box can be completed only after a physical visit to the plant to confirm that the practices, procedures,

material, etc. used in manufacturing the components are as described in the PID. This audit shall be carried out in accordance with the requirements of ESCC Basic Specification No. 20200 and the results shall be

formally recorded. The report number shall be referenced.

Box 10 Details entered shall be sufficient to evidenced that an evaluation programme according to ESCC Basic

Specification No. 24300 has been performed and that the results thereof are summarised in the audit and test reports. If the evaluation programme has not been carried out according to established ESCC Specifications, the applicant Executive Member shall provide alternative data and declare the assessed degree of satisfactory compliance with the ESCC requirements. Reference shall be made to the reports on Destructive Physical Analysis (DPA), Failure Analysis reports as well as any Non Conformance (NCCS) issued during the

Evaluation and/or capability approval testing.

Box 11 Enter the name of the Executive Member (i.e., CNES, DLR, ESTEC, etc.) and the signature and date of the

responsible Executive Coordinator.

Box 12 To be used when there is a need to expand any of the boxes from 1 through 10. Identify the Box affected and

reference Box 12 in the relevant Box. Box 12 can be broken into 12a, 12b, etc. if several boxes have to be

expanded.

In the case of Application for the Extension of Capability Approval, the Box 12 may be used to provide a summary of lots of component types (types, date codes, quantity) manufactured and tested within the

capability domain. Refer to ESCC 24300, paragraph 9.4.3 for complete requirements.

Box 13 State noncompliance with reference to specification(s) and paragraph(s). To simplify reference in Box 14 each

nonconformance shall be sequentially numbered. If relevant state 'None'.

Box 14 Any additional action deemed necessary by the Executive Member to bring the submitted data to a standard

likely to be accepted by the ESCC Executive should be listed herein or the reason(s) to accept the

noncompliance.

Box 15 All Executive Manager recommendations on the application itself, special conditions or restrictions,

modifications of the ESCC QPL entry, letters to the manufacturer, etc. shall be entered clearly in Box 15,

signed by the representative for ESA, and dated.